MA769

Silicon epitaxial planer type (cathode common)

For switching power supply

- Features
- Forward current (average) $I_{F(AV)}$: 10A type
- Repetitive peak reverse voltage V_{RRM} : 150V type

Absolute Maximum Ratings (Ta= 25°C)

Symbol

V_{RRM}

I_{F(AV)}

I_{FSM}*

Ti

Tstg

T_{opr}

Rating

150

10

80

- 40 to +125

- 40 to +125

-25 to +70

Unit

V

A

А

°C

°C

°C

- Sealed in TO-220F full-pack package, with high reliability
- Cathode common dual type

Parameter

Repetitive peak reverse voltage

Non-repetitive peak forward surge current

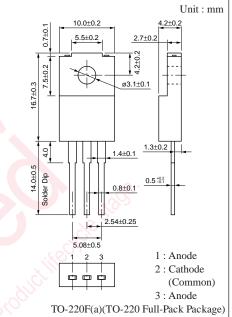
Operating ambient temperature

Average forward current

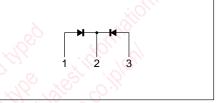
Junction temperature

Storage temperature

• Low forward voltage V_F



Internal Connection



* Sine half wave : 10ms/cycle

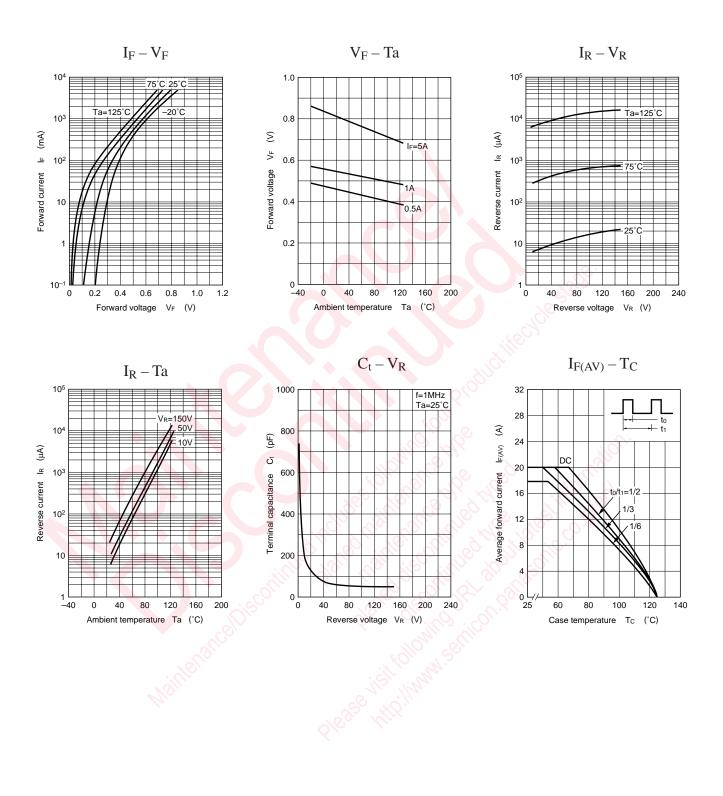
■ Electrical Characteristics (Ta= 25°C)

Parameter	Symbol	Condition	min	typ	max	Unit
Reverse current (DC)	IR	V _R =150V	00.,		3	mA
Forward voltage (DC)	VF	I _F = 5A			0.85	V
Thermal resistance	Rth(j-c)	Flat direct current between junction and case			3	°C/W

✤ Rated input/output frequency : 50MHz

Marking

Part Number	MA769			
Symbol	MA769			



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